

Description

The IRF540ZPBF uses advanced trench technology

to provide excellent RDS(ON), low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

 $V_{DS} = 100V I_{D} = 70A$

 $R_{DS(ON)}$ < 10.5m Ω @ V_{GS} =10V

Application

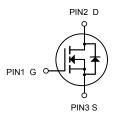
Battery protection

Load switch

Uninterruptible power supply

S D

TO-220 (TO-220AB-3)



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
IRF540ZPBF	TO-220(TO-220AB-3)	HXY MOSFET	50

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units		
Vos	Drain-Source Voltage	100	V		
Vgs	Gate-Source Voltage	Gate-Source Voltage ±20			
ID	Continuous Drain CurrentTC=25 °C	Continuous Drain CurrentTC=25 °C 70			
Ідм	PuledDrainCurrentnote1	PuledDrainCurrentnote1 280			
EAS	Single Pulse Avalanche Energy ³	110	mJ		
P _D @T _C =25°C	Total Power Dissipation ⁴	100	W		
Тѕтс	Storage Temperature Range	-55 to 150	°C		
TJ	Operating Junction Temperature Range	-55 to 150	°C		
R ₀ JA	Thermal Resistance Junction-Ambient ¹ 64		°C/W		
Rejc	Thermal Resistance Junction-Ambient ¹	1.25	°C/W		



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V	
2BVpss/2Tj	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.098		V/°C	
_		V _{GS} =10V , I _D =20A		8.5	10.5	mΩ	
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =15A		9.5	15	$m\Omega$	
V _{GS} (th)	Gate Threshold Voltage		1.0		2.5	V	
		V _{GS} =V _{DS} , I _D =250uA					
₹VGS(th)	V _{GS(th)} Temperature Coefficient	·		-4.57		mV/°C	
		V _{DS} =80V , V _{GS} =0V , T _J =25°C			1		
loss	Drain-Source Leakage Current	V _{DS} =80V , V _{GS} =0V , T _J =55°C			5	uA	
Igss	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA	
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		0.48		Ω	
Qg	Total Gate Charge (10V)			31.3			
Qgs	Gate-Source Charge	V _{DS} =50V , V _{GS} =50V , I _D =10A		3.49		nC	
Qgd	Gate-Drain Charge			7.63			
Td(on)	Turn-On Delay Time			16			
Tr	Rise Time	V _{DD} =50V , V _{GS} =10V , —R _G =4Ω		10			
Td(off)	Turn-Off Delay Time	RG=4Ω I _D =10A		40	-	ns	
Tf	Fall Time	ID- TOA		6			
Ciss	Input Capacitance			1368			
Coss	Output Capacitance	V _{DS} =50V , V _{GS} =0V , f=1MHz		451		pF	
Crss	Reverse Transfer Capacitance			12.9			
ls	Continuous Source Current ^{1,5}				70	Α	
lsм	Pulsed Source Current ^{2,5}	V _G =V _D =0V , Force Current			280	Α	
VsD	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V	
trr	Reverse Recovery Time	I=-40A		103		nS	
Qrr	Reverse Recovery Charge	lF=10A , dl/dt=100A/μs , T _J =25°C		187		nC	

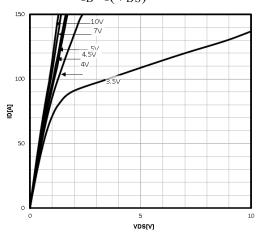
Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leqq 300us , duty cycle \leqq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH, I_{AS} =11A
- 4.The power dissipation is limited by 150°C junction temperature
- 5 .The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

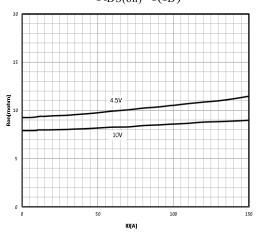


Typical Characteristics

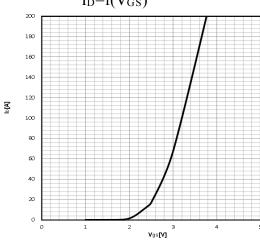
Typ. output characteristics $I_D=f(V_{DS})$



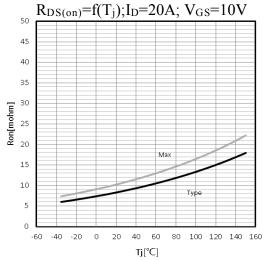
Typ. drain-source on resistance $R_{\mathrm{DS(on)}} = f(I_{\mathrm{D}})$



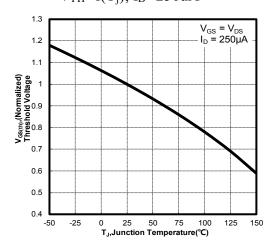
Typ. transfer characteristics $I_D=f(V_{GS})$



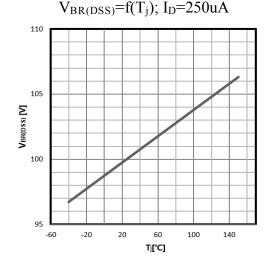
Drain-source on-state resistance



Gate Threshold Voltage V_{TH}=f(T_j); I_D=250uA

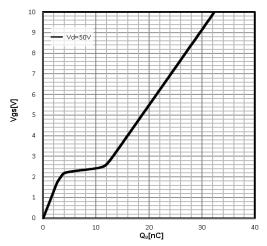


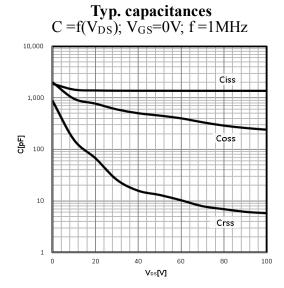
Drain-source breakdown voltage



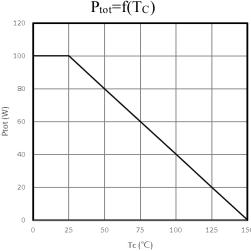


Typ. gate charge V_{GS} = $f(Q_g)$; I_D =10A

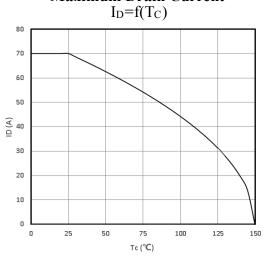




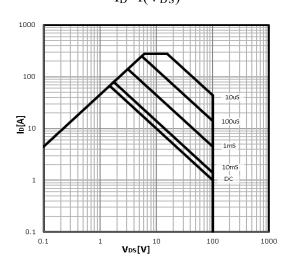
 $\begin{array}{c} \textbf{Power Dissipation} \\ P_{tot} \!\!=\!\! f(T_C) \end{array}$



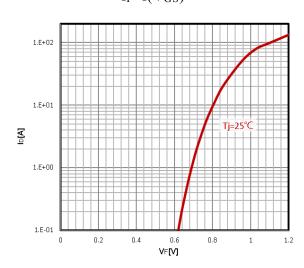
Maximum Drain Current



Safe operating area $I_D = f(V_{DS})$



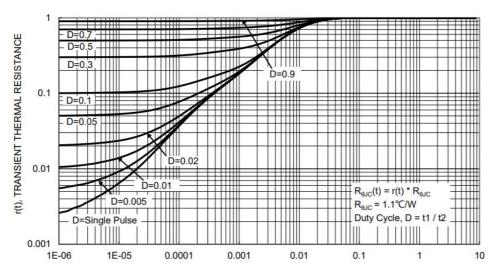
Body Diode Forward Voltage Variation $I_F = f(V_{\rm GS})$





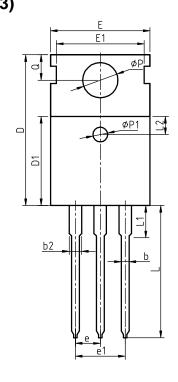
Max. transient thermal impedance

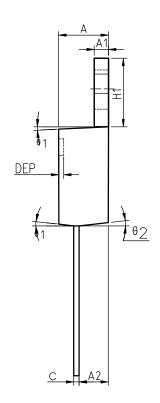




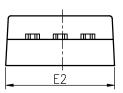


Package Information TO-220 (TO-220AB-3)





COMMON DIMENSIONS



SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX
Α	4.40	4.57	4.70	0.173	0.180	0. 185
A1	1.27	1.30	1.33	0.050	0.051	0.052
A2	2.35	2.40	2.50	0.093	0.094	0.098
b	0.77	0.80	0.90	0.030	0.031	0.035
b2	1.17	1.27	1.36	0.046	0.050	0.054
С	0.48	0.50	0.56	0.019	0.020	0.022
D	15.40	15.60	15.80	0.606	0.614	0.622
D1	9.00	9.10	9. 20	0.354	0.358	0.362
DEP	0.05	0.10	0.20	0.002	0.004	0.008
Е	9.80	10.00	10.20	0.386	0.394	0.402
E1	-	8.70	-	-	0.343	-
E2	9.80	10.00	10.20	0.386	0.394	0.402
е		2.54	BSC		0. 100	BSC
e1		5.08	BSC		0. 200	BSC
H1	6.40	6.50	6.60	0. 252	0. 256	0.260
L	12.75	13.50	13.65	0.502	0.531	0.537
L1	-	3. 10	3.30	-	0. 122	0.130
L2		2.50	REF		0.098	REF
Р	3.50	3.60	3.63	0.138	0.142	0.143
P1	3.50	3.60	3.63	0.138	0.142	0.143
Q	2.73	2.80	2.87	0.107	0.110	0.113
θ 1	5°	7°	9°	5°	7°	9°
θ 2	1°	3°	5°	1°	3°	5°
θ 3	1°	3°	5°	1°	3°	5°



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